

BIDIRECTIONAL THYRISTOR OVERVOLTAGE PROTECTORS

TISP4500H3BJ Overvoltage Protector

Ion-Implanted Breakdown Region Precise and Stable Voltage Low Voltage Overshoot under Surge

Device	V _{DRM}	V _(BO)
Device	V @ 0 °C	V @ 70 °C
TISP4500H3BJ	350	500

Rated for International Surge Wave Shapes

Wave Shape	Standard	IPPSM
wave Shape	Standard	Α
2/10	GR-1089-CORE	500
10/250	GR-1089-CORE	230
10/700	ITU-T K.20/21/45	200
10/1000	GR-1089-CORE	100



Device Symbol



SU UL Recognized Component

Description

This device is designed to limit overvoltages on the telephone line to ± 500 V over the temperature range. The minimum off-state voltage of ± 350 V allows a.c. power contact voltages of up to 245 V rms to occur without clipping. The combination of these two voltages gives protection for components having ratings of 500 V or above and ensures the protector is non-conducting for the ITU-T recommendations K.20/21/45 230 V rms power cross test condition (test number 2.3.1).

The protector consists of a symmetrical voltage-triggered bidirectional thyristor. Overvoltages are initially clipped by breakdown clamping until the voltage rises to the breakover level, which causes the device to crowbar into a low-voltage on state. This low-voltage on state causes the current resulting from the overvoltage to be safely diverted through the device. The high crowbar holding current helps prevent d.c. latchup as the diverted current subsides.

How To Order

Device	Package	Carrier	Order As	Marking Code	Std. Qty.
TISP4500H3BJ	SMB (DO-214AA)	Embossed Tape Reeled	TISP4500H3BJR-S	4500H3	3000

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Absolute Maximum Ratings, 0 $^\circ C \le T_{\mbox{A}} \le$ 70 $^\circ C$ (Unless Otherwise Noted)

Rating			Value	Unit	
Repetitive peak off-state voltage		V _{DRM}	±350	V	
Non-repetitive peak on-state pulse current (see Notes 1 and 2)					
2/10 (Telcordia GR-1089-CORE, 2/10 μs voltage wave shape) 10/250 (Telcordia GR-1089-CORE, 10/250 μs voltage wave shape) 10/700 (ITU-T K.20/21/45, 5/310 μs current wave shape) 10/1000 (Telcordia GR-1089-CORE, 10/1000 μs voltage wave shape)	T _A = 25 °C T _A = 25 °C T _A = 25 °C	I _{PPSM}	500 230 200 100	A	
Non-repetitive peak on-state current (see Notes 1, 2 and 3) 50 Hz, 20 ms (1 cycle) 50 Hz, 1000 s		I _{TSM}	±55 ±2.0	A	
Junction temperature		ТJ	-40 to +150	°C	
Storage temperature range		T _{stg}	-65 to +150	°C	

NOTES: 1. Initially the device must be in thermal equilibrium.

- 2. The surge may be repeated after the device returns to its initial conditions.
- 3. EIA/JESD51-2 environment and EIA/JESD51-3 PCB with standard footprint dimensions connected with 5 A rated printed wiring track widths.

Electrical Characteristics, 0 °C \leq T_A \leq 70 °C (Unless Otherwise Noted)

	Parameter	Test Conditions	Min	Тур	Max	Unit
IDRM	Repetitive peak off- state current	$V_D = V_{DRM}$ $T_A = 25 \degree C$ $T_A = 70 \degree C$			±5 ±10	μΑ
V _(BO)	Breakover voltage	$dv/dt = \pm 250 V/ms, R_{SOURCE} = 300 \Omega$			±500	V
V _(BO)	Impulse breakover voltage	ITU-T recommendation K.44 (02/2000) Figure A.3-1/K.44 10/700 impulse generator Charge Voltage = ±4 kV			±500	V
I _(BO)	Breakover current	dv/dt = ±250 V/ms, R_{SOURCE} = 300 Ω			±0.6	А
Ι _Η	Holding current	$I_T = \pm 5 \text{ A}, \text{ di/dt} = -/+30 \text{ mA/ms}$	±0.15			А
۱ _D	Off-state current	$V_D = \pm 50 \text{ V}$ $T_A = 70 \text{ °C}$			±10	μΑ
C _{off}	Off-state capacitance	$ f = 1 \text{ MHz, Vd} = 1 \text{ V rms, V}_D = 0 $ $ f = 1 \text{ MHz, Vd} = 1 \text{ V rms, V}_D = -1 \text{ V} $ $ f = 1 \text{ MHz, Vd} = 1 \text{ V rms, V}_D = -2 \text{ V} $ $ f = 1 \text{ MHz, Vd} = 1 \text{ V rms, V}_D = -50 \text{ V} $			84 67 62 31	pF

Thermal Characteristics

	Parameter	Test Conditions	Min	Тур	Max	Unit
$R_{\theta J A}$ Junction to free air the	Junction to free air thermal resistance	EIA/JESD51-3 PCB, $I_T = I_{TSM(1000)}$, $T_A = 25$ °C, (see Note 5)			113	°C/W
		265 mm x 210 mm populated line card, 4-layer PCB, $I_T = I_{TSM(1000)}$, $T_A = 25 °C$		50		0/11

NOTE 5: EIA/JESD51-2 environment and PCB has standard footprint dimensions connected with 5 A rated printed wiring track widths.

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Figure 1. Voltage-current Characteristic for T and R Terminals All Measurements are Referenced to the R Terminal

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MECHANICAL DATA



Device Symbolization Code

Devices will be coded as below. As the device parameters are symmetrical, terminal 1 is not identified.

Device	Symbolization Code
TISP4500H3BJ	4500H3

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